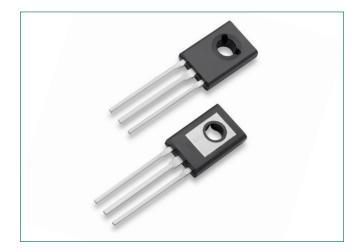


C106 Series



Description

Glassivated PNPN devices designed for high volume consumer applications such as temperature, light, and speed control; process and remote control, and warning systems where reliability of operation is important.

Features

- Glassivated Surface for Reliability and Uniformity
- Power Rated at Economical Prices
- Practical Level Triggering and Holding Characteristics
- Flat, Rugged, Thermopad Construction for Low Thermal Resistance, High Heat Dissipation and Durability

Po

- Sensitive Gate Triggering
- These are Pb–Free
 Devices

Functional Diagram



Additional Information



Datasheet



Samples

Pin Out



Additional Information

Maximum Ratings (T = 25°C unless otherwise noted)

v . j				
Rating	Symbol	Value	Unit	
Peak Repetitive Off-State Voltage (Sine Wave, 50-60 Hz, RGK = 1 K, TC = -40° to 110°C)	C106B C106D, C106D1* C106M	V _{drm} , V _{rrm}	200 400 600	V
On-State RMS Current (180° Conduction Angles, TC = 80°C)		I _{T (RMS)}	4.0	А
Average On–State Current (180° Conduction Angles, $T_c = 80$ °C)	I _{T(AV)}	2.55	А	
Peak Non-Repetitive Surge Current (1/2 Cycle, Sine Wave, 60 Hz, T _J = +25°C)	I _{TSM}	20	А	
Circuit Fusing Considerations (t = 8.3 ms)	l²t	1.65	A2s	
Forward Peak Gate Current (Pulse Width 1.0 sec, TC = 80°C)	I _{GM}	0.2	А	
Forward Peak Gate Power (Pulse Width \leq 1.0 $\mu sec, T_{_{\rm C}}$ = 80°C)	P _{GM}	0.5	W	
Forward Average Gate Power (Pulse Width \leq 1.0 $\mu sec,T_{_C}$ = 80°C)	P _{G(AV)}	0.1	W	
Operating Junction Temperature Range	TJ	-40 to +110	°C	
Storage Temperature Range	T _{stg}	-40 to +150	°C	
Mounting Torque (Note 2)	_	6.0	in. lb.	

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the

Recommended Operating Conditions may affect device reliability.
1. V_{PRM} and V_{RRM} for all types can be applied on a continuous basis. Ratings apply for zero or negative gate voltage; however, positive gate voltage shall not be applied concurrent with negative potential on the anode. Blocking voltages shall not be tested with a constant current source such that the voltage ratings of the devices are exceeded.

2. Torque rating applies with use of torque washer (Shakeproof WD19523 or equivalent). Mounting Torque in excess of 6 in. Ib. does not appreciably lower case-to-sink thermal resistance. Main terminal 2 and heat-sink contact pad are common.

Thermal Characteristics							
Rating		Symbol	Value	Unit			
Thermal Resistance,	Junction-to-Case (AC) Junction-to-Ambient	R _{ejc} R _{eja}	3.0 75	°C/W			
Maximum Lead Temperature for Soldering Pur 10 seconds	TL	260	°C				

Electrical Characteristics - OFF (T_j = 25°C unless otherwise noted)

Characteristic		Symbol	Min	Тур	Мах	Unit
Peak Repetitive Forward or Reverse Blocking Current	$T_{J} = 25^{\circ}C$	I _{drm} , I _{rrm}	-	-	10	μΑ
$(V_{AK} = Rated V_{DRM} \text{ or } V_{RRM'} R_{GK} = 1 \Omega k)$	$T_{J} = 110^{\circ}C$		-	-	100	μA

Electrical Characteristics - **ON** ($T_{J} = 25^{\circ}C$ unless otherwise noted)

Characteristic			Min	Тур	Мах	Unit
Peak Forward On-State Voltage (Note 3) ($I_{TM} = 4 A$)		V _{TM}	-	-	2.2	V
Gate Trigger Current (Continuous dc)	$T_J = 25^{\circ}C$		-	15	200	
$(V_{_{D}} = 12 \text{ V}, \text{ R}_{_{L}} = 100 \Omega, \text{ All Quadrants})$	$T_{J} = -40^{\circ}C$	GT	-	35	500	μA
Peak Reverse Gate Voltage ($I_{GR} = 10 \ \mu A$)		V _{GRM}	-	-	6.0	V
Gate Trigger Voltage (Continuous dc) ($V_p = 12$ Vdc, $R_L = 100 \Omega$, $T_c = 25^{\circ}C$)	$T_J = 25^{\circ}C$	V	0.4	0.60	0.8	V
	$T_{J} = -40^{\circ}C$	V _{GT}	0.5	0.75	1.0	
Gate Non-Trigger Voltage (Continuous dc) (Note 4) (V _{AK} = 12 V, R _L = 100 (VAK = 12 V, RL = 100 , TJ = 110°C), T _J = 110°C)		V _{gD}	0.2	-	_	V
Latching Current	$T_J = 25^{\circ}C$	1	-	0.20	5.0	
$(V_{AK} = 12 \text{ V}, \text{ I}_{g} = 20 \text{ mA}, \text{ R}_{gK} = 1 \text{ k}\Omega)$	$T_{J} = -40^{\circ}C$	i_	-	0.35	7.0	mA
Holding Current	T _J = 25°C		-	0.19	3.0	
$(V_p = 12 \text{ Vdc})$	$T_{J} = -40^{\circ}C$	I _H	-	0.33	6.0	mA
(Initiating Current = 20 mA, $R_{gK} = 1 k\Omega$)	$T_{J} = +110^{\circ}C$		_	0.07	2.0	1



Dynamic Characteristics					
Characteristic	Symbol	Min	Тур	Max	Unit
Critical Rate-of-Rise of Off State Voltage (V_{AK} = Rated V_{DRM} , Exponential Waveform, R_{GK} = 1k Ω , T_{J} = 110°C)	dv/dt	-	8.0	-	V/µs

3. Pulse Test: Pulse Width \leq 2.0 ms, Duty Cycle \leq 2%. **4.** R_{_{GK}} is not included in measurement.

Voltage Current Characteristic of SCR

Symbol	Parameter
V _{DRM}	Peak Repetitive Forward Off State Voltage
I	Peak Forward Blocking Current
V _{RRM}	Peak Repetitive Reverse Off State Voltage
I _{RRM}	Peak Reverse Blocking Current
V _{TM}	Maximum On State Voltage
I _H	Holding Current

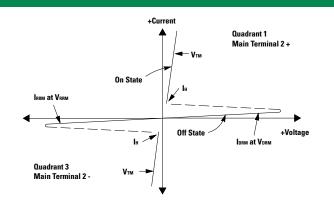




Figure 1. Average Current Derating

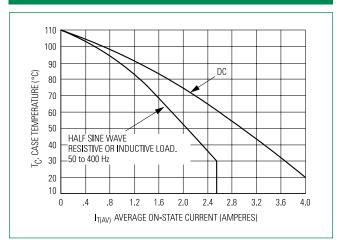


Figure 3. Typical Gate Trigger Current vs. Junction Temp

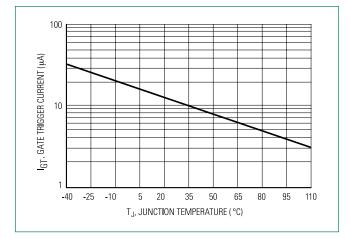


Figure 2. Maximum On-State Power Dissipation

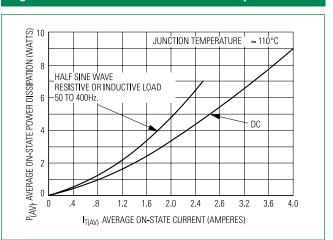


Figure 4. Typical Holding Current vs. Junction Temp

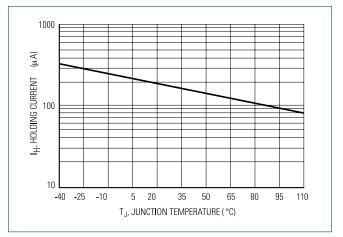


Figure 5. Typical Latching Current vs. Junction Temp

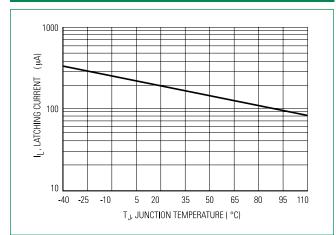
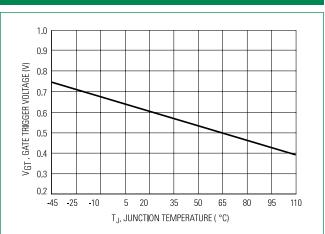
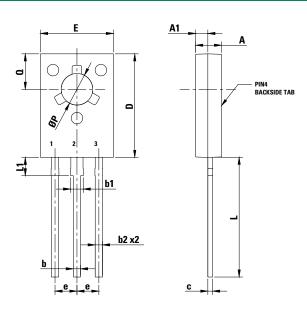


Figure 5. Typical Gate Trigger Voltage vs. Junction Temp

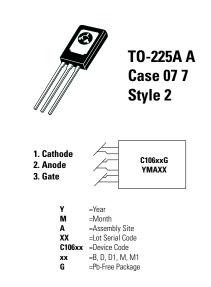




Dimensions



Part Marking System



Dim	Inc	hes	Millimeters		
UIM	Min	Max	Min	Max	
Α	0.102	0.110	2.60	2.80	
A1	0.047	0.055	1.20	1.40	
b	0.028	0.034	0.70	0.86	
b2	0.028	0.034	0.70	0.86	
С	0.019	0.022	0.49	0.57	
D	0.417	0.449	10.60	11.40	
E	0.291	0.323	7.40	8.20	
е	0.090 TYP		2.29 TYP		
L	0.551	0.630	14.00	16.00	
L1	0.091	0.106	2.30	2.70	
Р	0.118	0.134	3.00	3.40	
٥	0.142	0.157	3.60	4.00	
b1	0.047	0.055	1.2	1.4	

1	DIMENSIONING	AND TO	ERANCING P	PER ANSI Y14 5M	1982

2. CONTROLLING DIMENSION: INCH.

3. 077-01 THRU -08 OBSOLETE, NEW STANDARD 077-09.

Pin Assignment				
1	Cathode			
2	Anode			
3	Gate			

Ordering Information						
Device	Package	Shipping				
C106BG	-					
C106DG						
C106D1G*	TO225AA	2500 Units/Box				
C106MG	(Pb-Free)					
C106M1G*						
C106MTG		60 Units/Tube 1920 Units/Box				

*D1 signifies European equivalent for D suffix and M1 signifies European equivalent for M suffix.

Disclaimer Notice - Information furnished is believed to be accurate and reliable. However, users should independently evaluate the suitability of and test each product selected for their own applications. Littelfuse products are not designed for, and may not be used in, all applications. Read complete Disclaimer Notice at http://www.littelfuse.com/disclaimer-electronics.

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for SCRs category:

Click to view products by ON Semiconductor manufacturer:

Other Similar products are found below :

 NTE5428
 T1500N16TOF VT
 TT162N16KOF-A
 TT162N16KOF-K
 TT330N16AOF
 VS-22RIA20
 VS-2N685
 057219R
 T1190N16TOF VT

 T1220N22TOF VT
 T201N70TOH
 T700N22TOF
 T830N18TOF
 TT250N12KOF-K
 VS-16RIA120
 VS-110RKI40
 NTE5427
 NTE5442

 TT251N16KOF-K
 VS-22RIA100
 VS-16RIA40
 TD250N16KOF-A
 VS-ST110S16P0
 T930N36TOF VT
 T2160N24TOF VT
 T1190N18TOF

 VT
 T1590N28TOF VT
 2N1776A
 T590N14TOF
 NTE5375
 NTE5460
 NTE5481
 NTE5512
 NTE5518
 NTE5519
 NTE5529

 NTE5553
 NTE5557
 NTE5567
 NTE5570
 NTE5572
 NTE5576
 NTE5578
 NTE5579
 NTE5592
 NTE5598